

## PRODUCT FEATURES

- IGBT chip in trench FS-technology
- Low switching losses
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery



## APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies

## IGBT-inverter

### ABSOLUTE MAXIMUM RATINGS

$T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_C$	DC Collector Current	$T_C=25^\circ\text{C}$	75	A
		$T_C=80^\circ\text{C}$	50	
$I_{CM}$	Repetitive Peak Collector Current	$t_p=1\text{ms}$	100	
$P_{tot}$	Power Dissipation Per IGBT		300	W

## Diode-inverter

### ABSOLUTE MAXIMUM RATINGS

$T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current	$T_C=25^\circ\text{C}$	25	A
$I_{FRM}$	Repetitive Peak Forward Current	$t_p=1\text{ms}$	50	
$i^2t$		$T_J=125^\circ\text{C}$ , $t=10\text{ms}$ , $V_R=0\text{V}$	170	$\text{A}^2\text{S}$

**IGBT-inverter**  
**ELECTRICAL CHARACTERISTICS**
 $T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=2\text{mA}$	5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=50\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		2.2	2.5	
		$I_C=50\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.5		
$I_{CES}$	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			100	$\mu\text{A}$
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$			1	$\text{mA}$
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=125^\circ\text{C}$	-400		400	$\text{nA}$
$R_{gint}$	Integrated Gate Resistor			0		$\Omega$
$Q_g$	Gate Charge	$V_{CE}=600\text{V}, I_C=50\text{A}, V_{GE}=15\text{V}$		0.28		$\mu\text{C}$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		7.2		$\text{nF}$
$C_{res}$	Reverse Transfer Capacitance				80	$\text{pF}$
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=50\text{A}$ $R_G=20\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		110	$\text{ns}$
			$T_J=125^\circ\text{C}$		120	$\text{ns}$
$t_r$	Rise Time	Inductive Load	$T_J=25^\circ\text{C}$		35	$\text{ns}$
			$T_J=125^\circ\text{C}$		45	$\text{ns}$
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=600\text{V}, I_C=50\text{A}$ $R_G=20\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		320	$\text{ns}$
			$T_J=125^\circ\text{C}$		360	$\text{ns}$
$t_f$	Fall Time	Inductive Load	$T_J=25^\circ\text{C}$		50	$\text{ns}$
			$T_J=125^\circ\text{C}$		60	$\text{ns}$
$E_{on}$	Turn on Energy	$V_{CC}=600\text{V}, I_C=50\text{A}$ $R_G=20\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		3	$\text{mJ}$
			$T_J=125^\circ\text{C}$		5.5	$\text{mJ}$
$E_{off}$	Turn off Energy	Inductive Load	$T_J=25^\circ\text{C}$		1.8	$\text{mJ}$
			$T_J=125^\circ\text{C}$		2.3	$\text{mJ}$
$I_{sc}$	Short Circuit Current	$tp_{sc}\leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=125^\circ\text{C}, V_{CC}=600\text{V}$		200		A
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT )				0.4	$\text{K/W}$

**Diode-inverter**  
**ELECTRICAL CHARACTERISTICS**
 $T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=25\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.65	2.15	V
		$I_F=25\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.65		
$t_{rr}$	Reverse Recovery Time	$I_F=25\text{A}, V_R=600\text{V}$		120		$\text{ns}$
$I_{RRM}$	Max. Reverse Recovery Current	$di_F/dt=-800\text{A}/\mu\text{s}$		42		A
$Q_{RR}$	Reverse Recovery Charge	$T_J=125^\circ\text{C}$		5.5		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy				2.1	$\text{mJ}$
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode )				1.25	$\text{K/W}$

**MODULE CHARACTERISTICS**

$T_C=25^{\circ}\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$T_{Jmax}$	Max. Junction Temperature		150	°C
$T_{Jop}$	Operating Temperature		-40~125	
$T_{stg}$	Storage Temperature		-40~125	
$V_{isol}$	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 200	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M5)	2.5~5	Nm
Weight			160	g

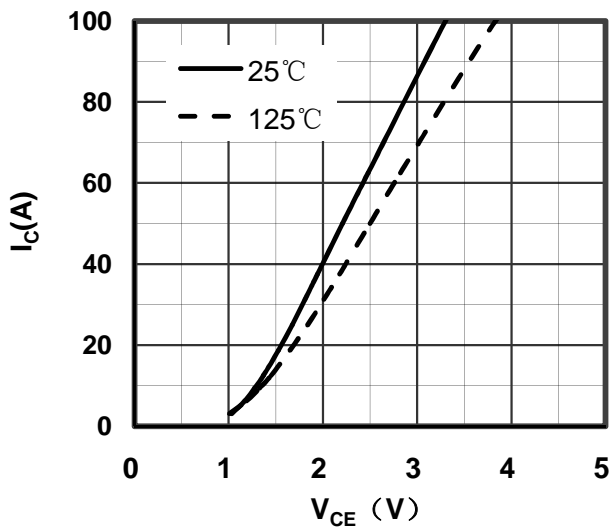


Figure 1. Typical Output Characteristics IGBT-inverter

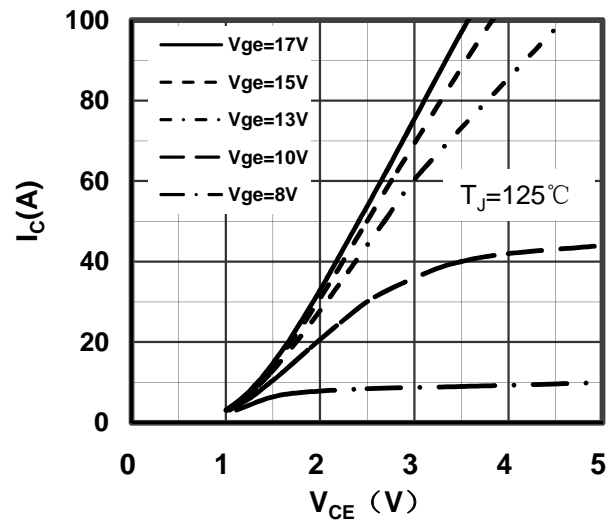


Figure 2. Typical Output Characteristics IGBT-inverter

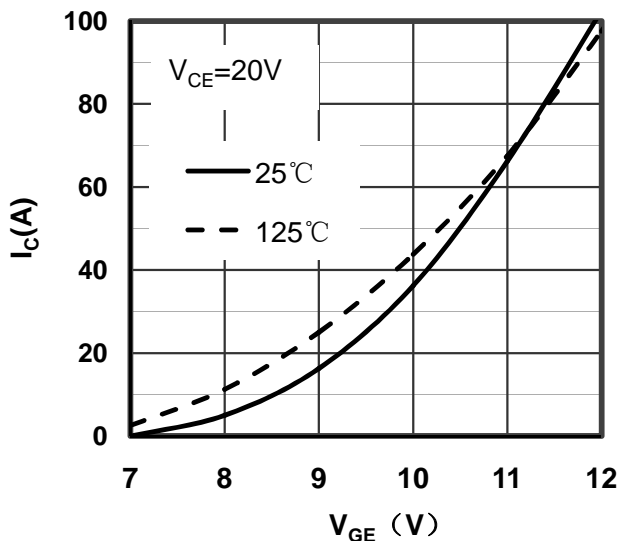


Figure 3. Typical Transfer characteristics IGBT-inverter

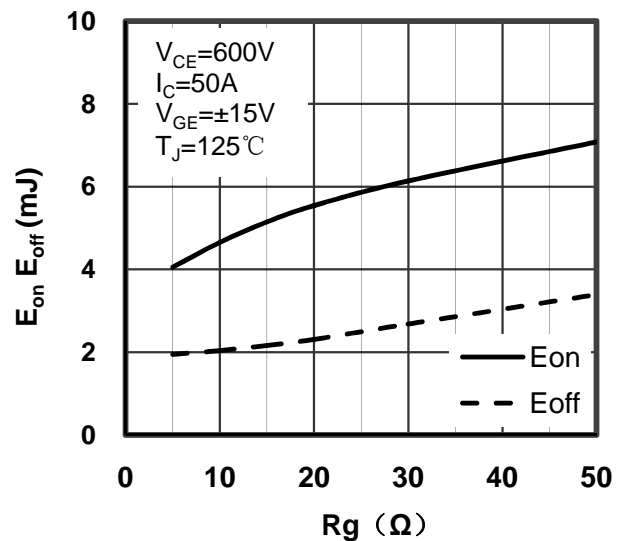


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

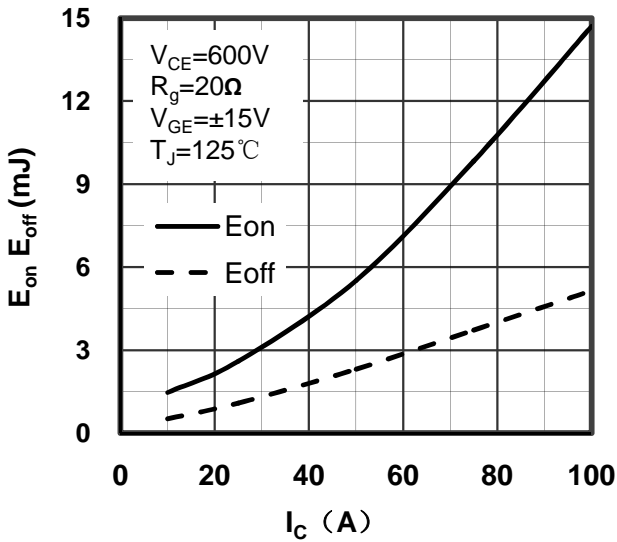


Figure 5. Switching Energy vs Collector Current IGBT-inverter

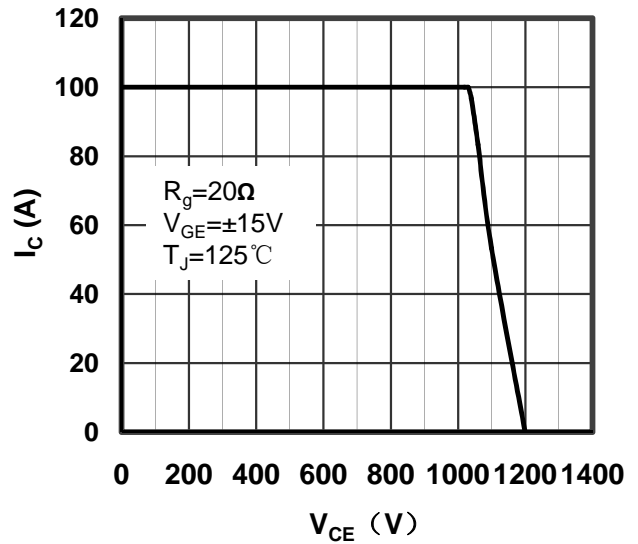


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

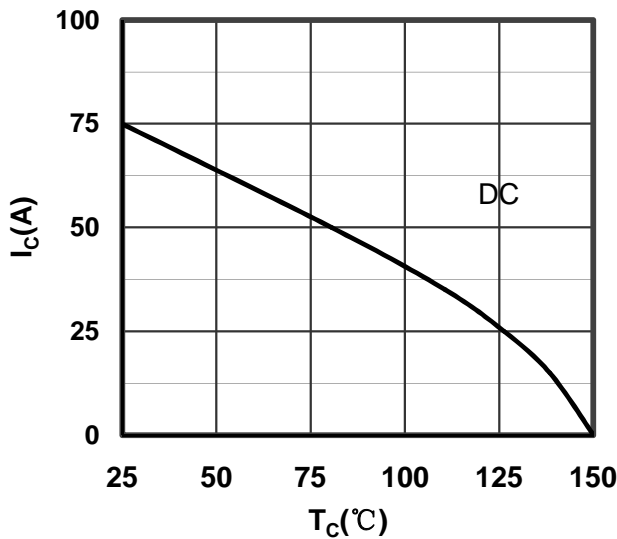


Figure 7. Collector Current vs Case temperature IGBT-inverter

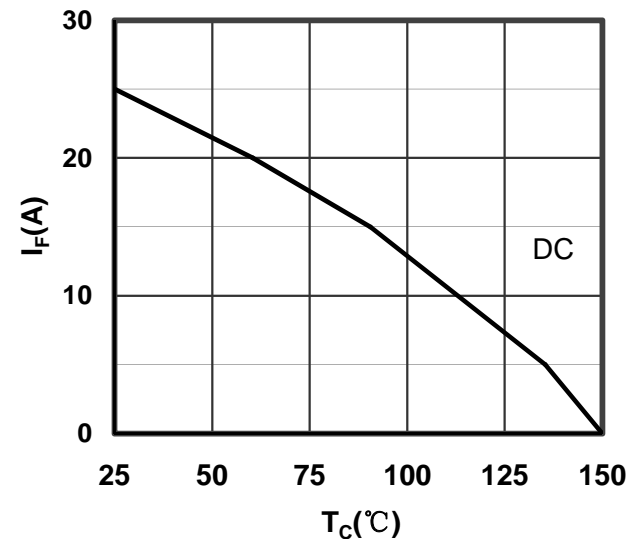


Figure 8. Forward current vs Case temperature Diode-inverter

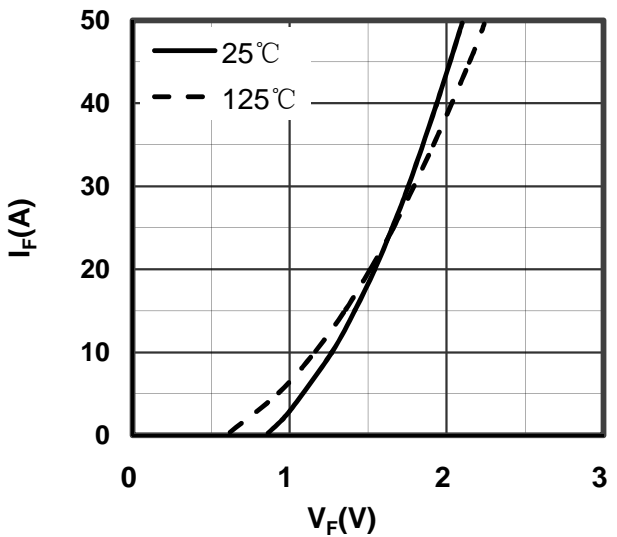


Figure 9. Diode Forward Characteristics Diode-inverter

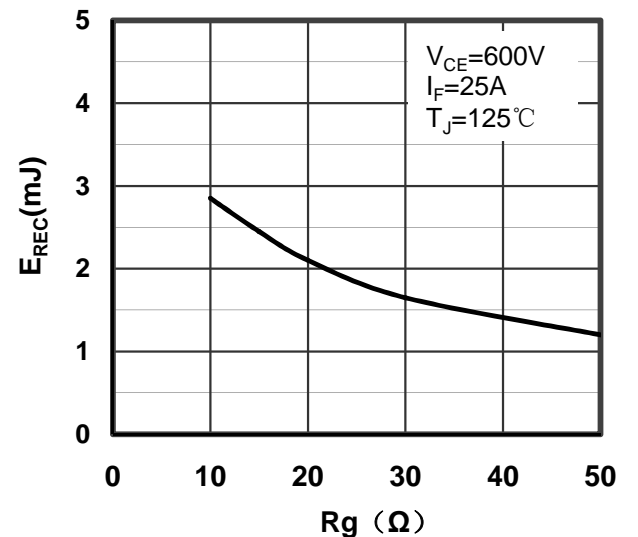


Figure 10. Switching Energy vs Gate Resistor Diode-inverter

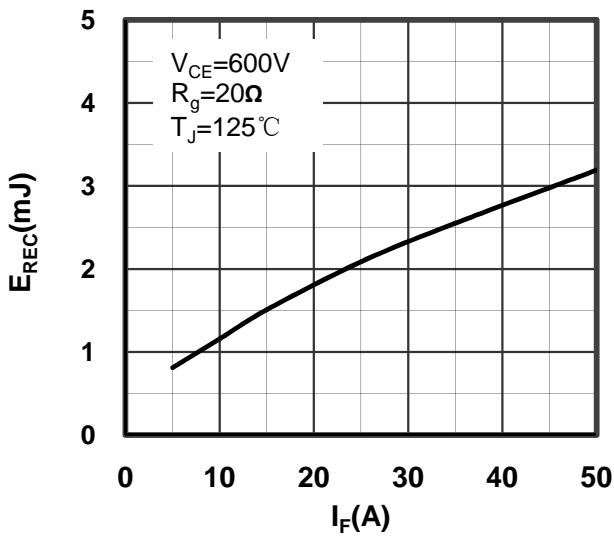


Figure 11. Switching Energy vs Forward Current Diode-inverter

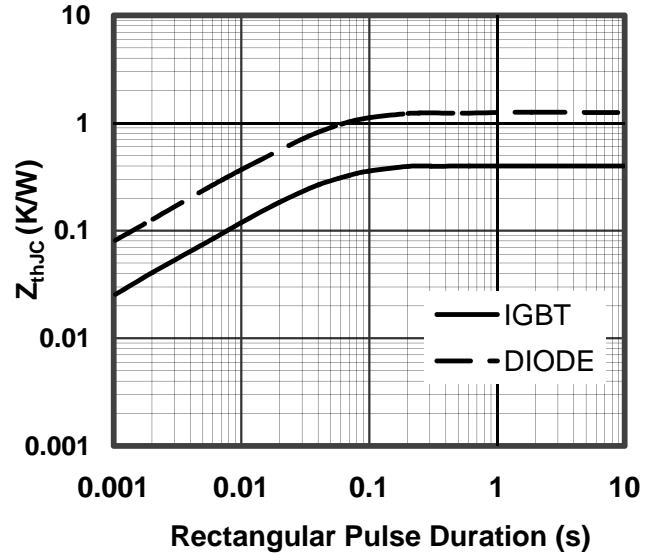


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

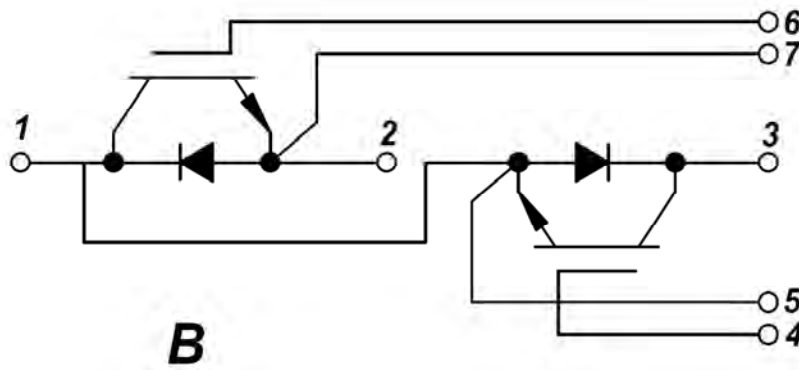
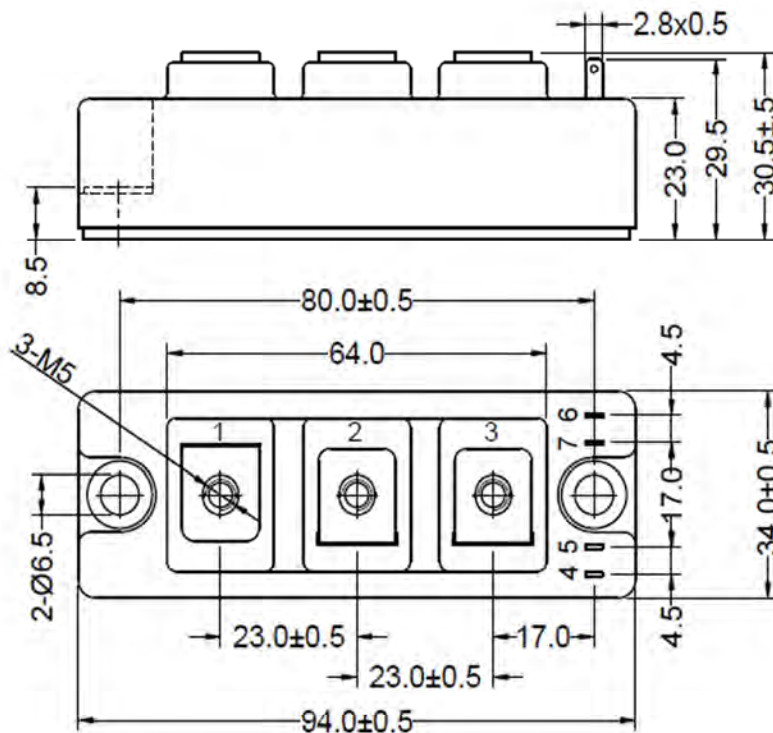


Figure 13. Circuit Diagram



Dimensions in (mm)  
Figure 14. Package Outline